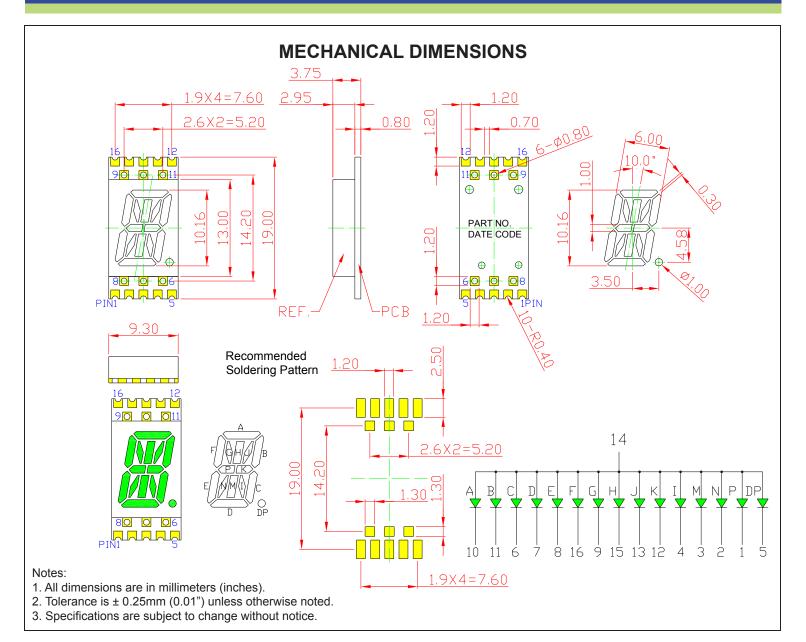


SPECIFICATIONS SDSAN40G1W



Part Number	Chip Material	Color of Emission	Lens Type	Description
SDSAN40G1W	GaP	Green	White Segment	Common Anode





ABSOLUTE MAXIMUM RATINGS

 $(TA=25^{\circ}C)$

Parameter	Symbol		Unit	
Power Dissipation per Dice	Pad	70	mW	
Derating Liner from 25°C per Dice	-	0.28	mA / °C	
Continuous Forward Current per Dice	laf	25	mA	
Peak Current per Dice (duty cycle 1/10, 1kHz)	lpf	90	mA	
Reverse Voltage per Dice	VR	5	°C	
Operating Temperature	Topr	-40~+105	°C	
Storage Temperature	Тѕтс	-40~+105	°C	

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Characteristic	Symbol	Condition	Value			I Imit
Characteristic			Min.	Type.	Max.	Unit
Forward Voltage per Dice	VF	I⊧ =10mA	1.8	2.3	2.6	V
Reverse Current per Dice	lR	V _R = 5V	-	-	10	μΑ
Peak Wavelength per Dice	λР	IF =10mA	-	568	-	nm
Dominant Wavelength per Dice	λD	IF =10mA	569	570	574	nm
Luminous Intensity per Dice	lv	IF =10mA	-	3	-	mcd
Spectral Radiation Bandwidth per Dice	Δλ	IF =10mA	-	30	-	nm

^{*}Tolerance of viewing angle: -10 / +5 deg.

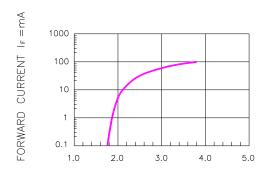


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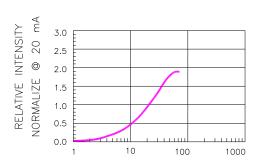


OPTICAL CHARACTERISTIC CURVES

Typical Electro-optical Characteristic Curves (25 °C Free Air Temperature Unless Otherwise Specified)



FORWARD VOLTAGE (V)
Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE



FORWARD CURRENT (mA)
Fig.2 RELATIVE INTENSITY VS. FORWARD CURRE

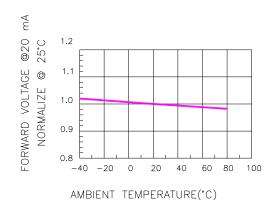


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

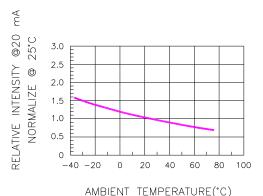


Fig.4 RELATIVE INTENSITY VS. TEMPERATUI

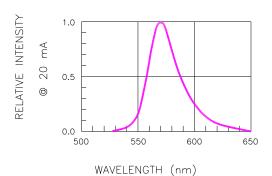
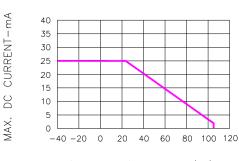


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH



AMBIENT TEMPERATURE (TA)-°C

Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE



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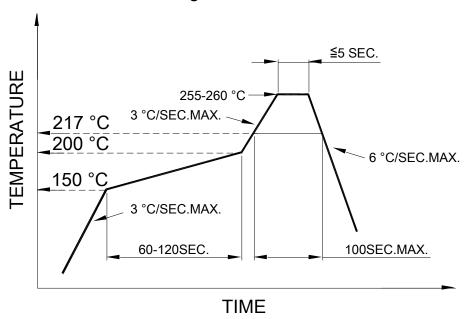


SOLDERING CONDITIONS – LAMP TYPE LED

SMT REFLOW SOLDERING INSTRUCTIONS

SMT Soldering Profile

Pb free reflow soldering Profile

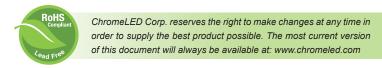


SOLDERING IRON

Basic spec is ≦4 sec when 260°C. If temperature is higher, time should be shorter (+10°C→1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

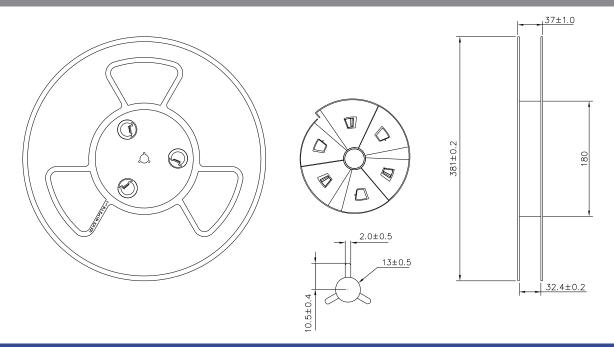
REWORK

- Customer must finish rework within 5 sec. under 260°C.
- The head of soldering iron cannot touch copper foil.





DIMENSIONS OF TAPE (Unit: mm)



PACKAGING SPECIFICATION

